

12A, 650V SiC Merged PIN Schottky Diode

FEATURES

- Max junction temperature 175°C
- MPS structure for high ruggedness to forward current surge events
- High-speed switching possible
- High forward surge capability
- High-frequency operation
- Positive temperature coefficient on V_F
- RoHS compliant
- Halogen-free

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- General purpose
- Switch mode power supplies
- Power factor correction

MECHANICAL DATA

• Case: TO-220AC-2L

Molding compound meets UL 94V-0 flammability rating

• Terminal: Matte tin plated leads, solderable per J-STD-002

Polarity: As circuit diagram

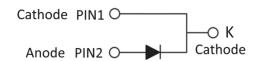
• Weight: 2.03g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
l _F	12	Α			
V_{RRM}	650	V			
I _{FSM}	88	Α			
T _{J MAX}	175	°C			
Package	TO-220AC-2L				
Configuration	Single die				





TO-220AC-2L



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	VALUE	UNIT		
Repetitive peak reverse voltage	V_{RRM}	650	V		
Reverse voltage, total rms value	V _{R(RMS)}	455	V		
Continuous Rectified Forward Current @ T _J =	lf	12	Α		
Surge peak forward current 10ms single half	$T_C = 25^{\circ}C$	I _{FSM}	88	Α	
sine-wave superimposed on rated load	Tc = 125°C		68	Α	
Junction temperature	TJ	-55 to +175	°C		
Storage temperature	T _{STG}	-55 to +175	°C		



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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	MAX	UNIT	
Junction-to-case thermal resistance	Rejc	1.20	1.44	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
	$I_F = 6A, T_J = 25^{\circ}C$	VF	1.15	-	V
	$I_F = 12A, T_J = 25^{\circ}C$		1.36	1.45	V
Forward voltage(1)	$I_F = 6A, T_J = 150$ °C		1.19	-	V
Forward voltage ⁽¹⁾	$I_F = 12A, T_J = 150$ °C		1.57	-	V
	I _F = 6A, T _J = 175°C		1.21	-	V
	I _F = 12A, T _J = 175°C		1.65	1.85	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C	l _R	-	20	μA
Reverse current @ rated VR	T _J = 175°C	IR	-	200	μA
	$f = 1MHz, V_R = 1V$		490	-	pF
Junction capacitance	$f = 1MHz, V_R = 200V$	С	78.0	-	pF
	f = 1MHz, V _R = 400V		55.3	-	pF
Capacitive Charge	V _R = 400V	Qc	37.2	-	nC

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE	PACKAGE	PACKING			
TSCDT12065G1	TO-220AC-2L	50 / Tube			



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Typical Forward Characteristics

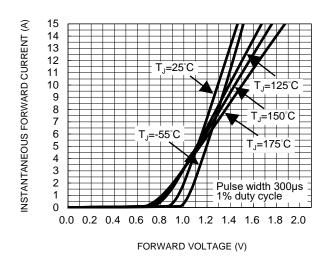


Fig.3 Peak forward current versus case temperature

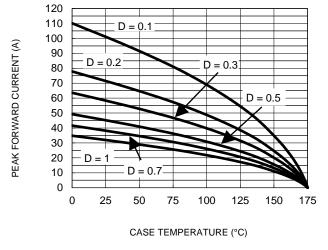


Fig.5 Typical Capacitive Charge

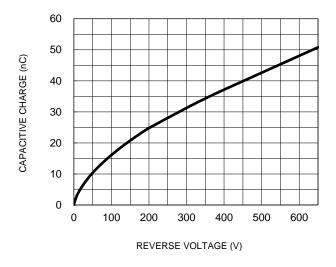


Fig.2 Typical Reverse Characteristics

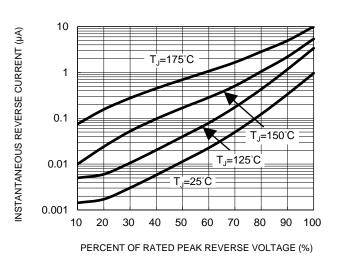


Fig.4 Typical Junction Capacitance

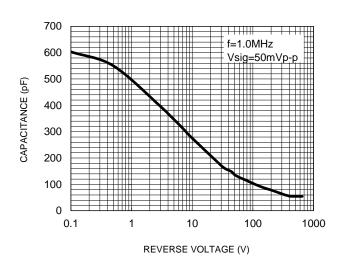
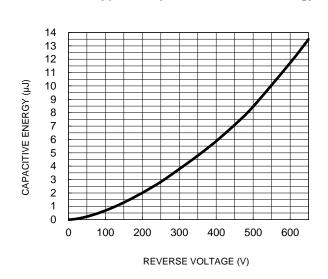


FIG.6 Typical Capacitance Stored Energy

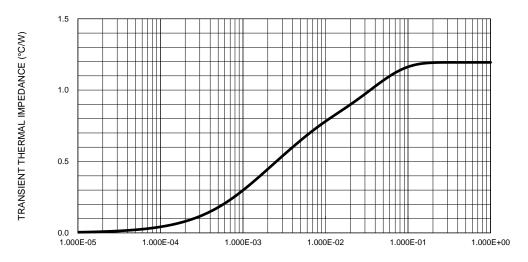




CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.7 Typical Transient Thermal Characteristics

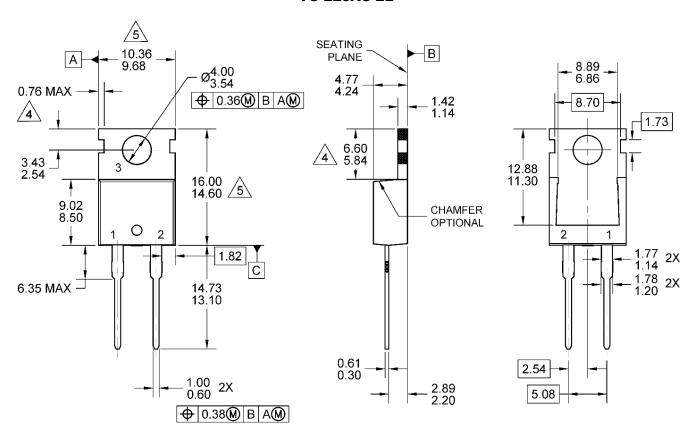


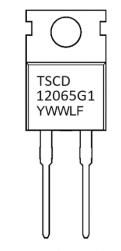
PULSE DURATION (s)



PACKAGE OUTLINE DIMENSIONS

TO-220AC-2L





MARKING DIAGRAM

Y = YEAR CODE

WW = WEEK CODE (01~52)

L = LOT CODE (1~9, A~Z)

F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC TO-220, VARIATION AC, ISSUE K.
- THE DEFINED ZONE WHERE STAMPING AND SINGULATION IRREGULARITIES ARE ALLOWED. SLOT AND NOTCH MAY APPEAR IN THIS ZONE.
- THIS DO NOT INCLUDE MOLD FLASH.
 THESE DIMENSIONS ARE MEASURED AT
 THE OUTERMOST EXTREME OF THE
 PLASTIC BODY.
- 6. DWG NO REF: HQ2SD07-TO220ACSiC-119 REV A.



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